

MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

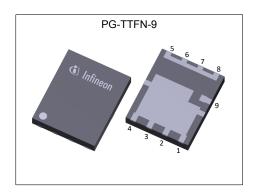
- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

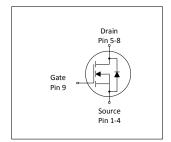
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

| rable i reginerimanes i arametere | | | | | | | |
|-----------------------------------|-------|------|--|--|--|--|--|
| Parameter | Value | Unit | | | | | |
| $V_{	extsf{DS}}$ | 60 | V | | | | | |
| $R_{	extsf{DS(on)},	ext{max}}$ | 0.9 | mΩ | | | | | |
| I _D | 445 | A | | | | | |
| Qoss | 127 | nC | | | | | |
| Q _G | 120 | nC | | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|-----------|---------|---------------|
| IQD009N06NM5CG | PG-TTFN-9 | 00906NC | - |

OptiMOS[™] 5 Power-Transistor, 60 V



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OptiMOS[™] 5 Power-Transistor, 60 V IQD009N06NM5CG



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

| Danamatan | 0 | Values | | | | |
|--|-----------------------------------|-------------|-------------|-------------------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | - - - | - - - | 445 315 268 42 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾ |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 1780 | Α | <i>T</i> _C =25 °C |
| Avalanche energy, single pulse ⁴⁾ | E AS | - | - | 1115 | mJ | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 333 3.0 | W | T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾ |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 175 | °C | - |

2 Thermal characteristics

Table 3 Thermal characteristics

| Darameter | Symbol | Values | | | Unit | Note / Test Condition |
|--|-------------------|--------|------|------|------|-----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | - | 0.45 | °C/W | - |
| Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾ | R _{thJA} | - | - | 50 | °C/W | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Static characteristics Table 4

| Damain Adam | 0 | | Values | | | |
|----------------------------------|----------------------|------|------------|-------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 60 | - | - | V | V _{GS} =0 V, I _D =1 mA |
| Gate threshold voltage | V _{GS(th)} | 2.1 | 2.8 | 3.3 | V | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 163 \mu {\rm A}$ |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μΑ | V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I_{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 0.8 1.1 | 0.9 1.27 | mΩ | V _{GS} =10 V, I _D =50 A V _{GS} =6 V, I _D =50 A |
| Gate resistance | R _G | - | 0.5 | - | Ω | - |
| Transconductance | g fs | 95 | 190 | - | S | V _{DS} ≥2 I _D R _{DS(on)max} , I _D =50 A |

Table 5 **Dynamic characteristics**

| Davamatav | Cymphal | Values | | | 11 | Nata / Tant Candition | |
|--|------------------|--------|------|-------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Input capacitance ¹⁾ | C _{iss} | - | 9000 | 12000 | pF | V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz | |
| Output capacitance ¹⁾ | Coss | - | 1800 | 2300 | pF | V _{GS} =0 V, V _{DS} =30 V, f=1 MHz | |
| Reverse transfer capacitance ¹⁾ | C _{rss} | - | 110 | 190 | pF | V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz | |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 17 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Rise time | t _r | - | 9 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Turn-off delay time | $t_{\sf d(off)}$ | - | 34 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Fall time | t _f | - | 12 | - | ns | $V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |

Table 6 Gate charge characteristics²⁾

| Parameter | Oh. a.l. | Values | | | Ī., ., | |
|------------------------------------|----------------------|--------|------|------|--------|--|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 38 | - | nC | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold | $Q_{g(th)}$ | - | 25 | - | nC | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge ¹⁾ | $Q_{ m gd}$ | - | 20 | 30 | nC | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge | Q _{sw} | - | 33 | - | nC | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total ¹⁾ | Qg | - | 120 | 150 | nC | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage | V _{plateau} | - | 4.2 | - | V | $V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total, sync. FET | Q _{g(sync)} | - | 107 | - | nC | V _{DS} =0.1 V, V _{GS} =0 to 10 V |
| Output charge ¹⁾ | Qoss | - | 127 | 169 | nC | V _{DS} =30 V, V _{GS} =0 V |

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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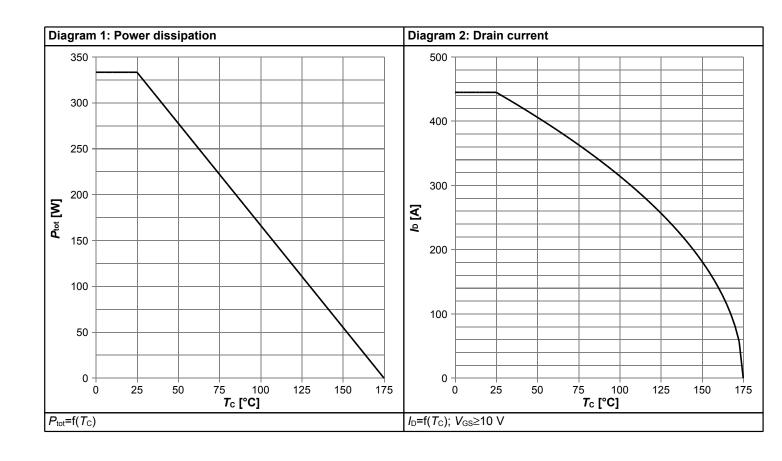


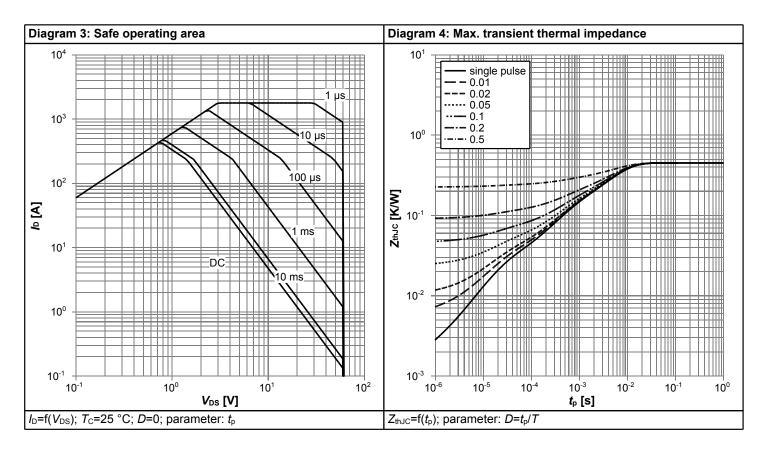
Table 7 Reverse diode

| Parameter | Complete | Values | | | 11:4 | Nata / Tast Candition |
|--|----------------------|--------|------|------|------|---|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continuous forward current | Is | - | - | 252 | Α | <i>T</i> _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 1780 | Α | T _C =25 °C |
| Diode forward voltage | V _{SD} | - | 0.81 | 1.0 | V | V _{GS} =0 V, I _F =50 A, T _j =25 °C |
| Reverse recovery time ¹⁾ t_{rr} | | - | 45 | 90 | ns | V _R =30 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs |
| Reverse recovery charge ¹⁾ | Q _{rr} | - | 51 | 102 | nC | V _R =30 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs |

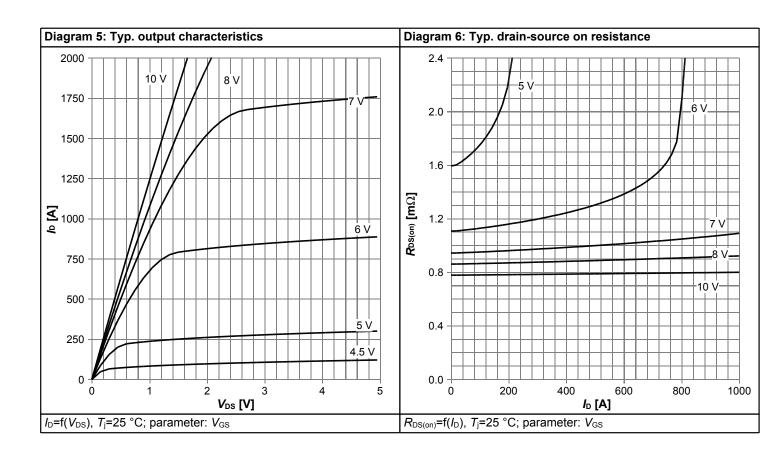


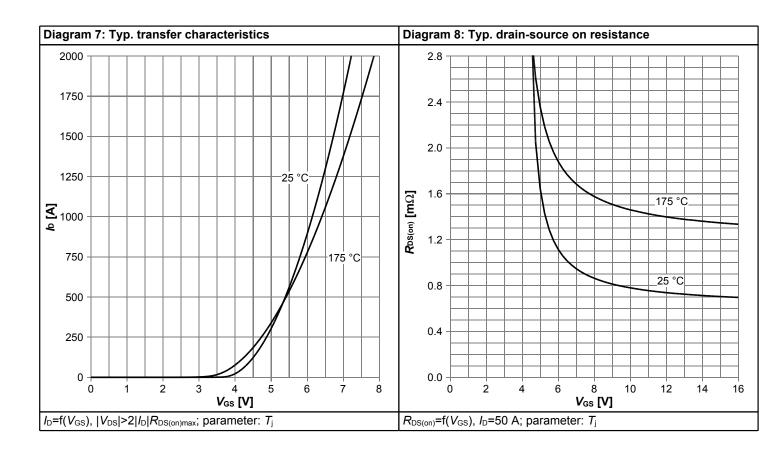
4 Electrical characteristics diagrams



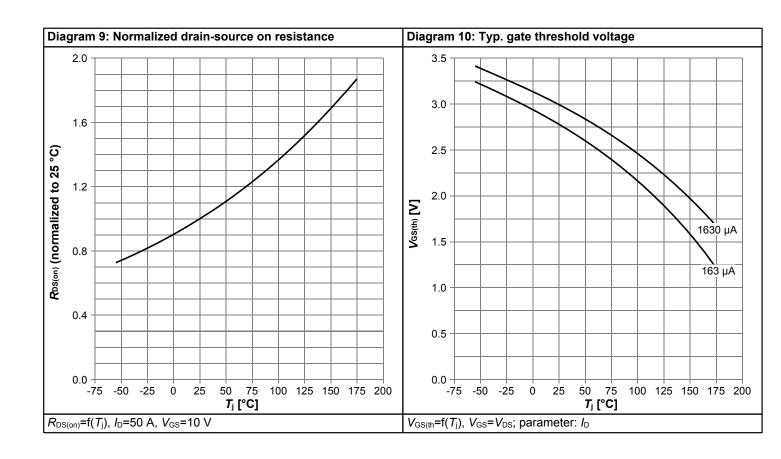


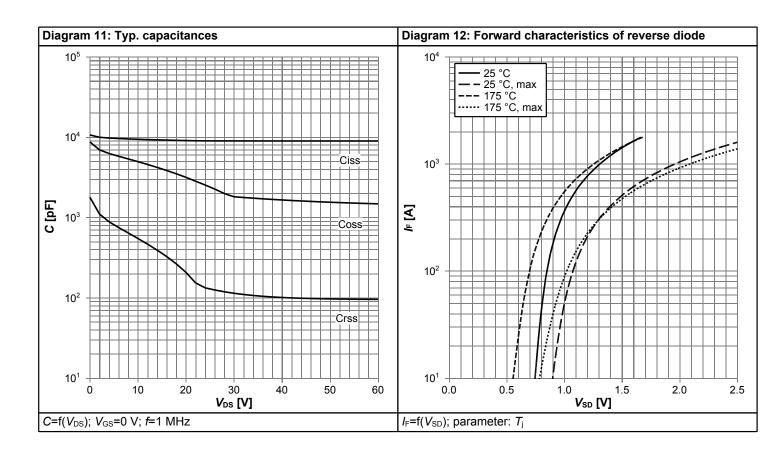




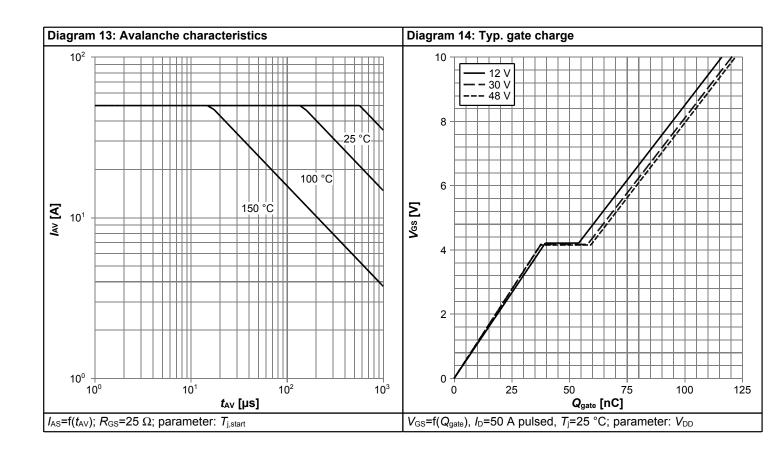


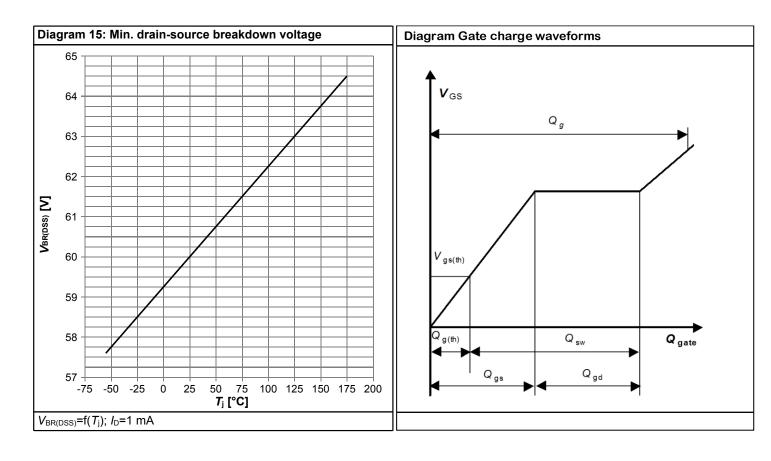














5 Package Outlines

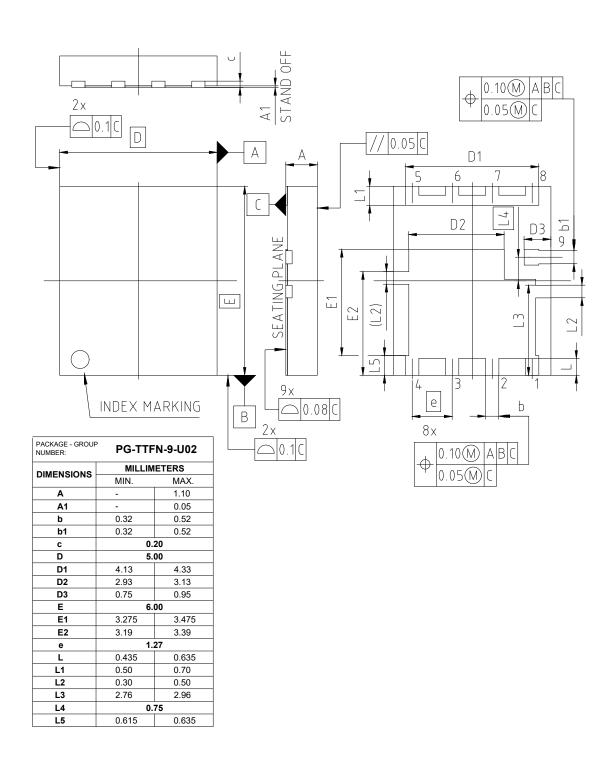


Figure 1 Outline PG-TTFN-9, dimensions in mm

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Revision History

IQD009N06NM5CG

Revision: 2023-03-06, Rev. 2.1

Previous Revision

| T To Wood of No. 100 March | | | | | | | |
|--|---|--|--|--|--|--|--|
| Revision | evision Date Subjects (major changes since last revision) | | | | | | |
| 2.0 | 2022-12-19 | Release of final version | | | | | |
| 2.1 | 2023-03-06 | Update RG, EAS, Rds(on) at VGS 6V and Id for VGS(th) | | | | | |

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